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AO4443

40V P-Channel MOSFET

General Description

The AO4443 combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{\rm DS(ON)}$. This device is ideal for load switch and battery protection applications.

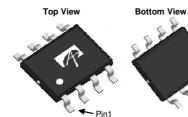
Product Summary

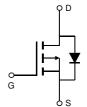
 $\begin{array}{lll} V_{DS} & -40V \\ I_{D} \; (at \; V_{GS} \!\!=\!\! -10V) & -6A \\ R_{DS(ON)} \; (at \; V_{GS} \!\!=\!\! -10V) & < 42m\Omega \\ R_{DS(ON)} \; (at \; V_{GS} \!\!=\!\! -4.5V) & < 63m\Omega \end{array}$

100% UIS Tested 100% R_g Tested



SOIC-8





Absolute Maximum Ratings T_A=25℃ unless otherwise noted

Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V_{DS}	-40	V	
Gate-Source Voltage		V_{GS}	±20	V	
Continuous Drain	T _A =25℃		-6		
Current	T _A =70℃	'D	-5	Α	
Pulsed Drain Current ^C		I _{DM}	-40	1	
Avalanche Current ^C		I _{AS} , I _{AR}	20	Α	
Avalanche energy L=0.1mH ^C		E _{AS} , E _{AR}	20	mJ	
	T _A =25℃	—P _D	3.1	W	
Power Dissipation ^B	T _A =70℃	' D	2		
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	C	

Thermal Characteristics								
Parameter		Symbol	Тур	Max	Units			
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{\theta JA}$	31	40	℃/W			
Maximum Junction-to-Ambient AD	Steady-State	П _Ө ЈА	59	75	℃/W			
Maximum Junction-to-Lead	Steady-State	$R_{\theta JL}$	16	24	℃/W			



Electrical Characteristics (T_J=25℃ unless otherwise noted)

STATIC PA	ADAMETEDS				Тур	Max	Units				
CIAIICIA	ANAIVIETENS	STATIC PARAMETERS									
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$		-40			V				
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} =-40V, V_{GS} =0V				-1	μΑ				
	Zero date voltage Brain durrent	$T_{J}=5$				-5	μΑ				
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±20V				±100	nA				
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=-250\mu A$		-1.5	-2	-2.6	V				
	On state drain current	V _{GS} =-10V, V _{DS} =-5V		40			Α				
	Static Drain-Source On-Resistance	V_{GS} =-10V, I_D =-6A			35	42	mΩ				
R _{DS(ON)}			T _J =125℃		53	65	11122				
		V_{GS} =-4.5V, I_{D} =-5A			46.5	63	mΩ				
g _{FS}	Forward Transconductance	V_{DS} =-5V, I_{D} =-6A			17		S				
V_{SD}	Diode Forward Voltage	$I_S=-1A, V_{GS}=0V$			-0.76	-1	V				
I_S	Maximum Body-Diode Continuous Current					-3.5	Α				
DYNAMIC	PARAMETERS										
C_{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =-20V, f=1MHz		750	940	1175	рF				
C _{oss}	Output Capacitance				97		рF				
C_{rss}	Reverse Transfer Capacitance				72		рF				
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		7	14	21	Ω				
SWITCHIN	IG PARAMETERS										
$Q_{g(10V)}$	Total Gate Charge	V _{GS} =-10V, V _{DS} =-20V, I _D =-6A			17.3	22	nC				
Qg _(4.5V)					8.4	11					
Q_{gs}	Gate Source Charge				3.2		nC				
Q_{gd}	Gate Drain Charge				4.3		nC				
t _{D(on)}	Turn-On DelayTime				10.3		ns				
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-20V, R_L =3.35 Ω , R_{GEN} =3 Ω			4.3		ns				
t _{D(off)}	Turn-Off DelayTime				39		ns				
t _f	Turn-Off Fall Time				46.5		ns				
t _{rr}	Body Diode Reverse Recovery Time	I _F =-6A, dI/dt=100A/μs			17	24	ns				
	Body Diode Reverse Recovery Charge	1 04 11/1: 1004/			11.5		nC				

A. The value of R_{BJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The value in any given application depends on the user's specific board design. B. The power dissipation P_D is based on $T_{J(MAX)}=150^\circ$ C, using \leqslant 10s junction-to-ambient thermal resistance. C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}=150^\circ$ C. Ratings are based on low frequency and duty cycles to keep

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Rev 4: August 2011 Page 2 of 5 www.aosmd.com

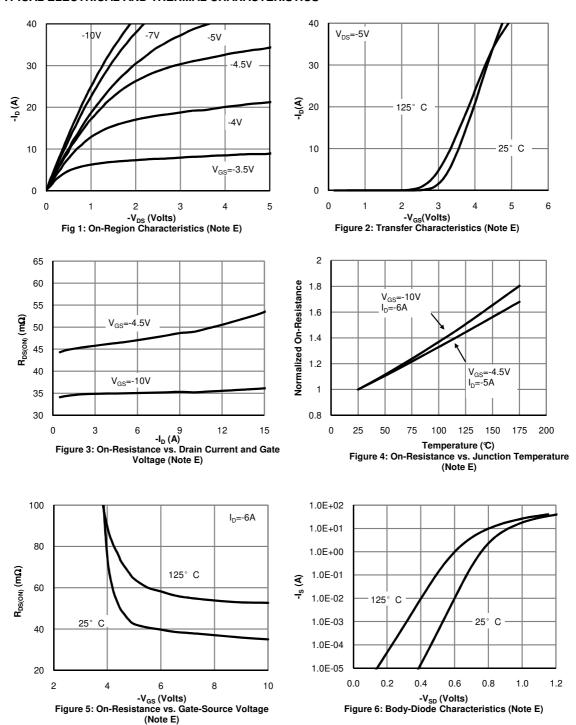
D. The $R_{\theta JA}$ is the sum of the thermal impedence from junction to lead $R_{\theta JL}$ and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedence which is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, assuming a maximum junction temperature of T_{J(MAX)}=150° C. The SOA curve provides a single pulse rating.

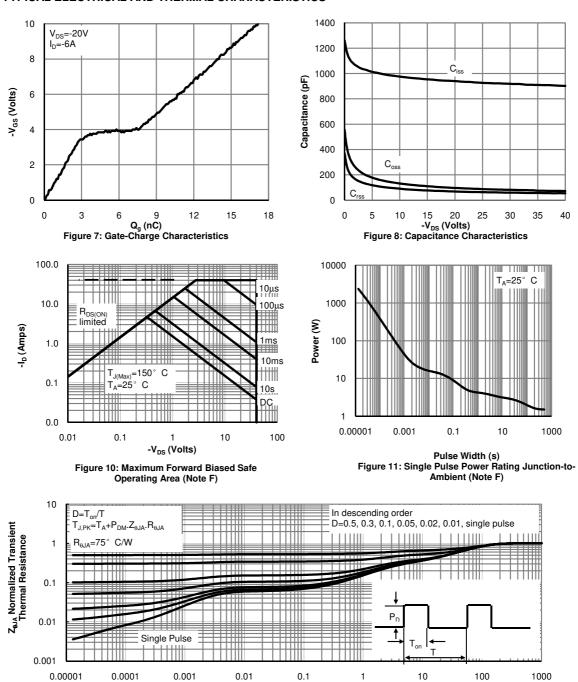


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





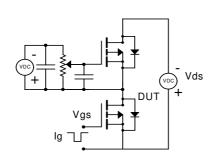
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

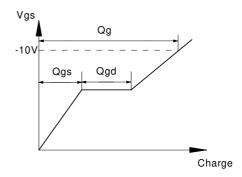


Pulse Width (s)
Figure 12: Normalized Maximum Transient Thermal Impedance (Note F)

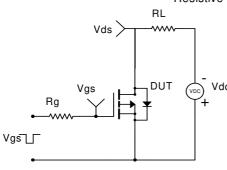


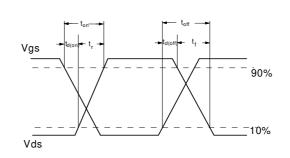
Gate Charge Test Circuit & Waveform



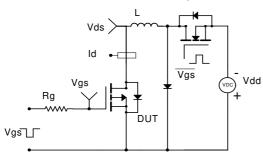


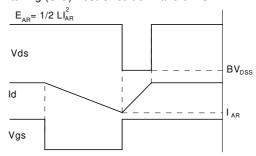
Resistive Switching Test Circuit & Waveforms





Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

